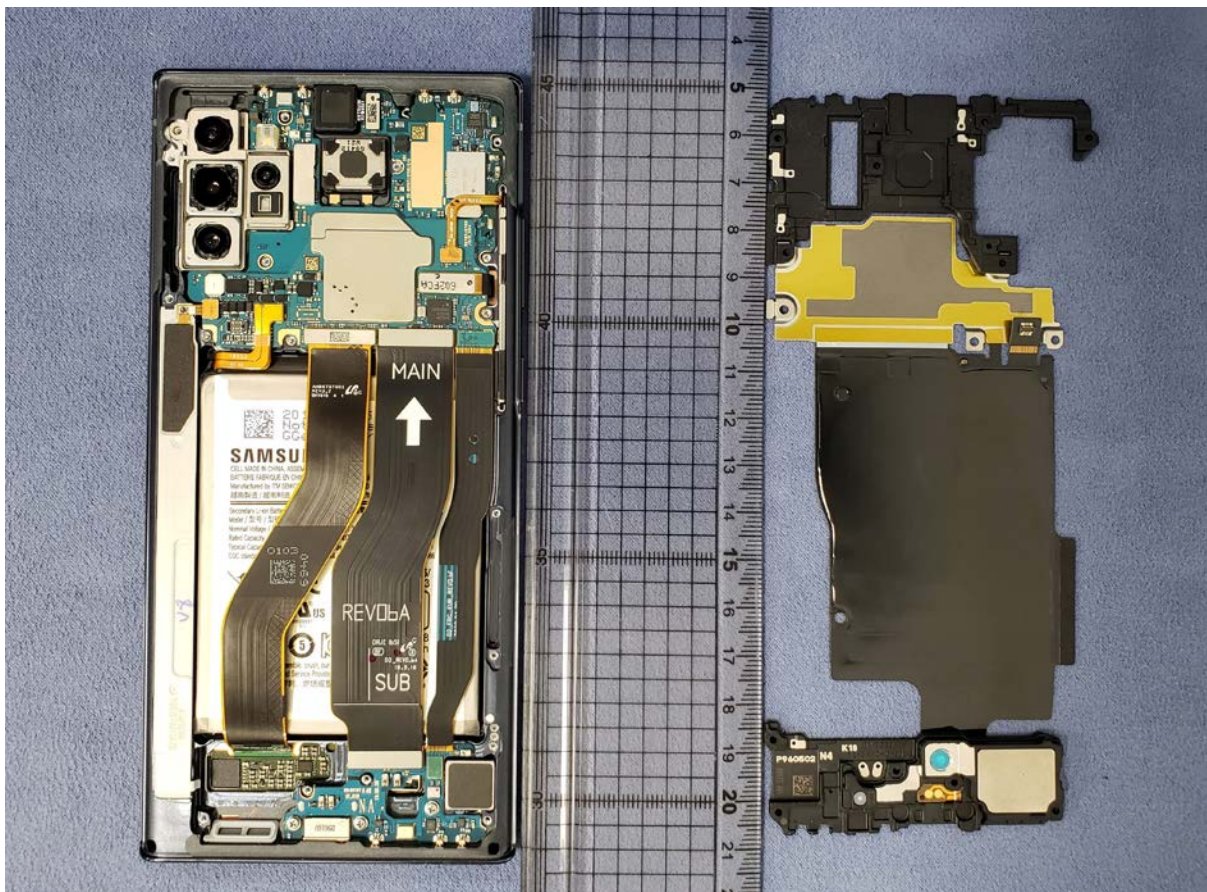
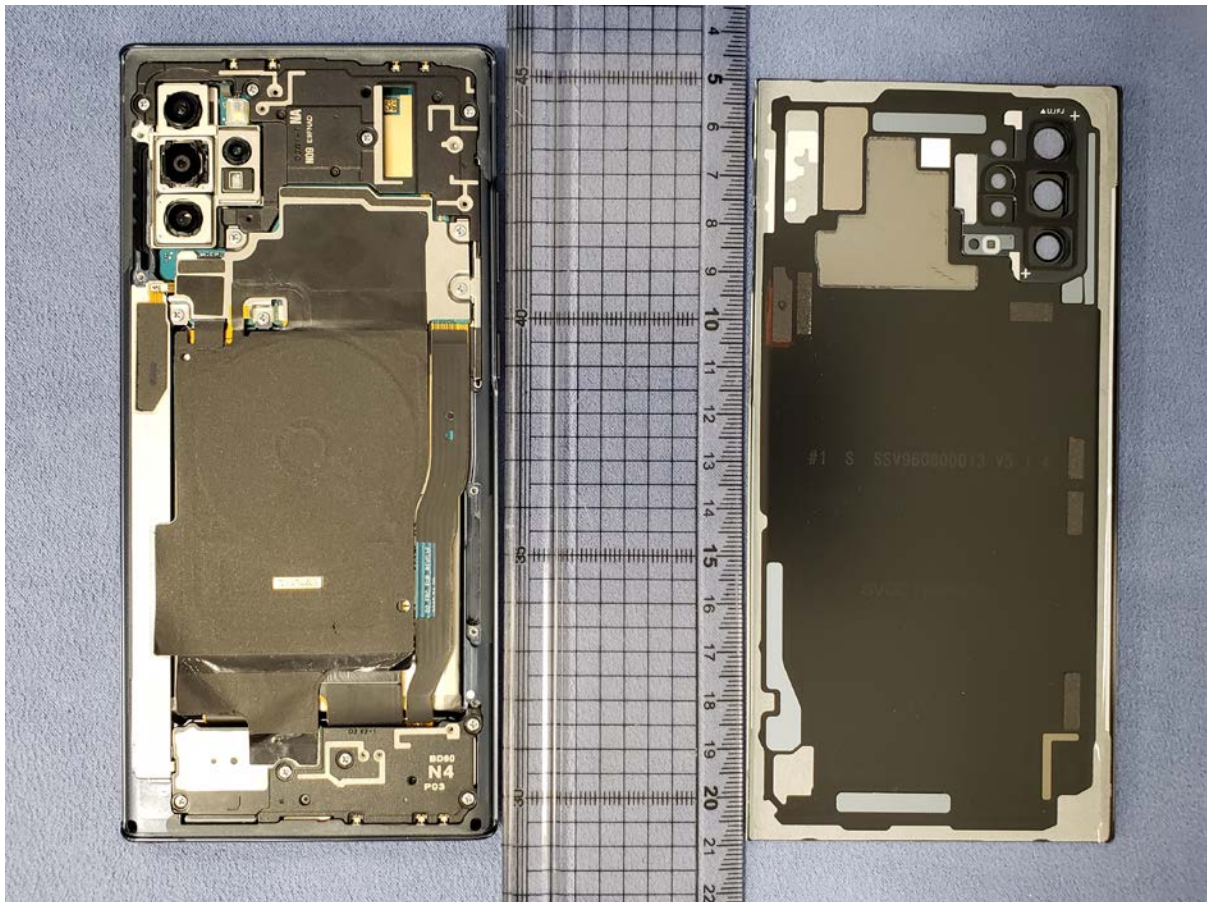


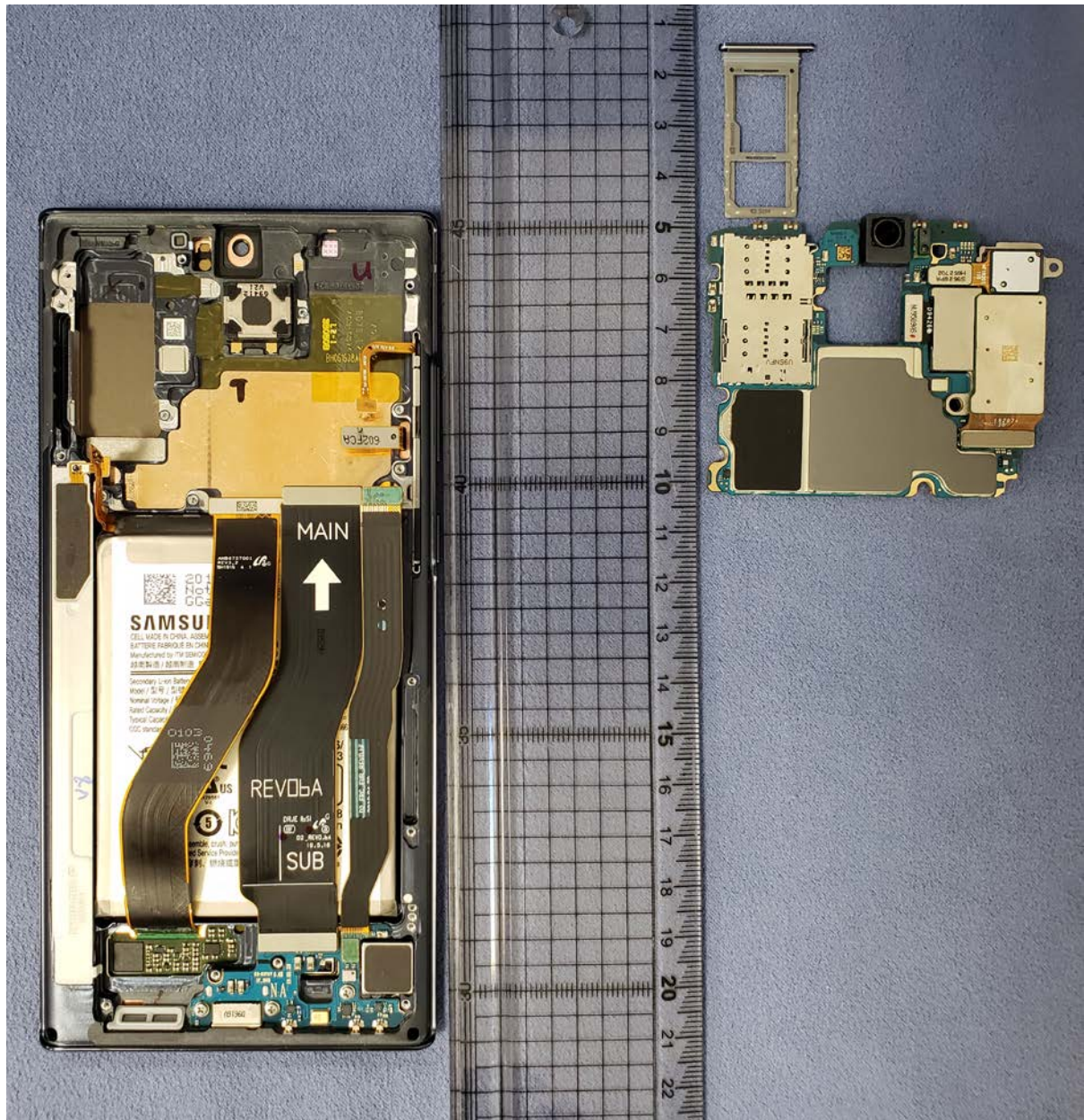
A3LSMN975U

Internal Photographs



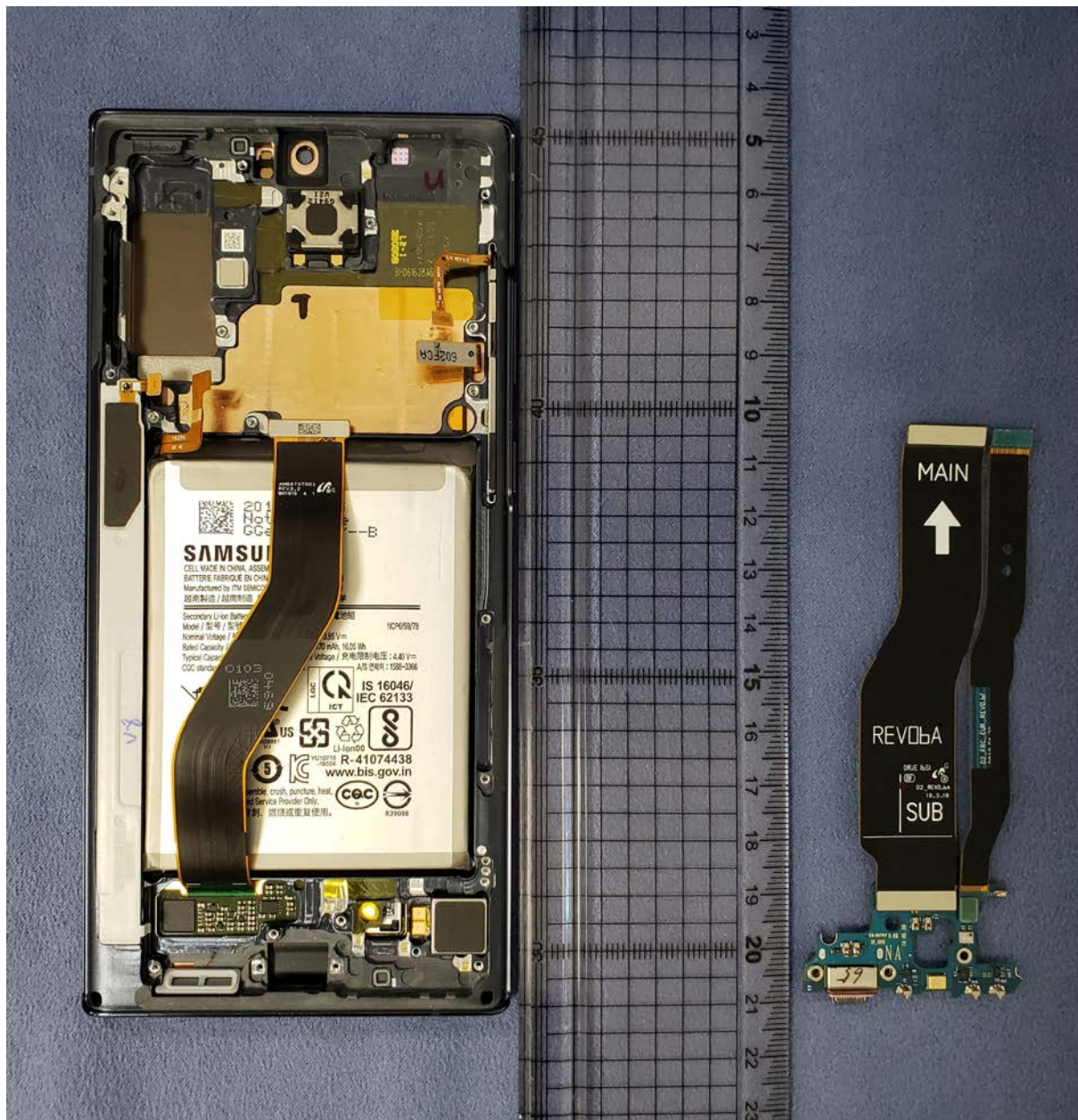
A3LSMN975U

Internal Photographs



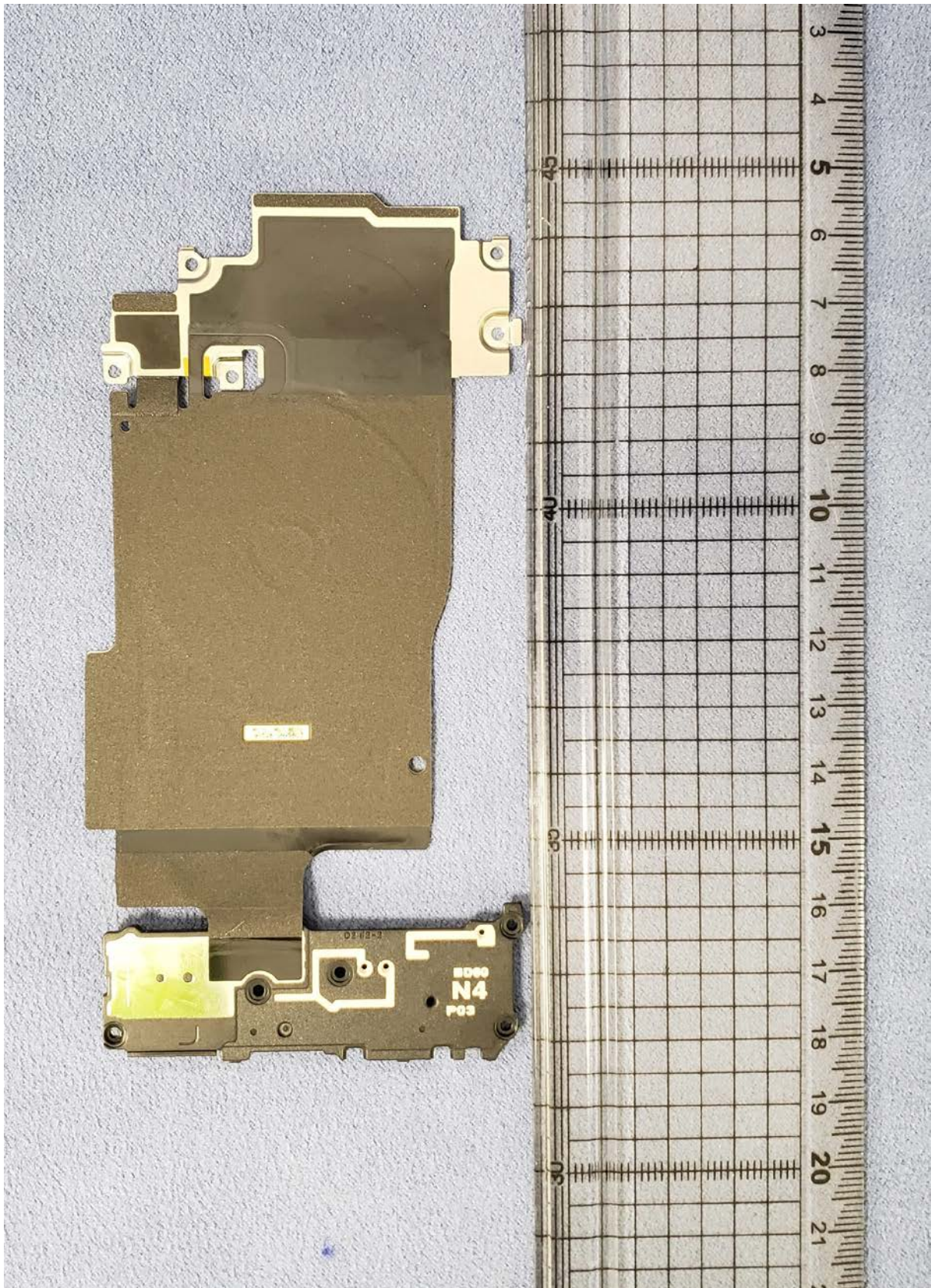
A3LSMN975U

Internal Photographs



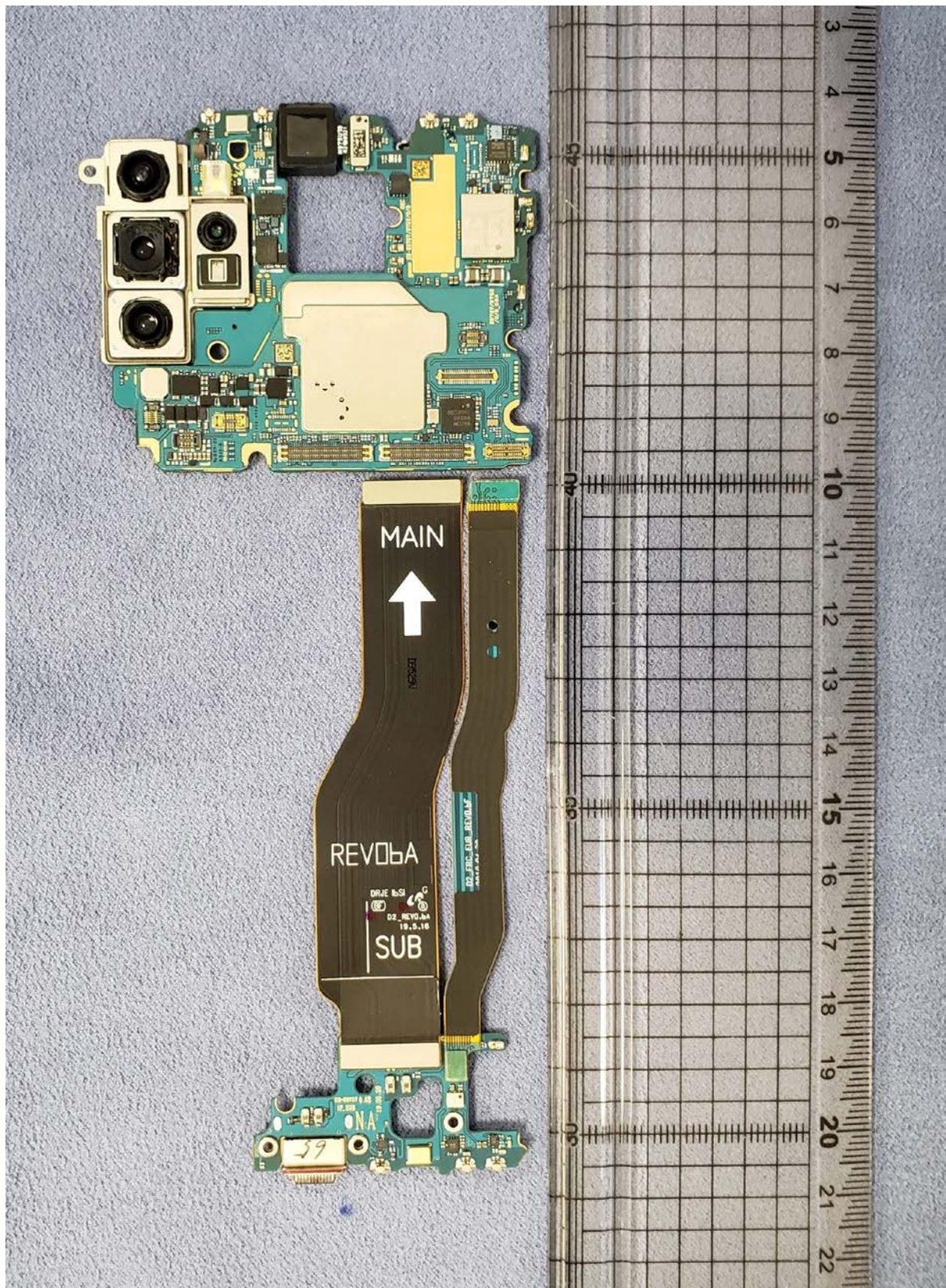
A3LSMN975U

Internal Photographs



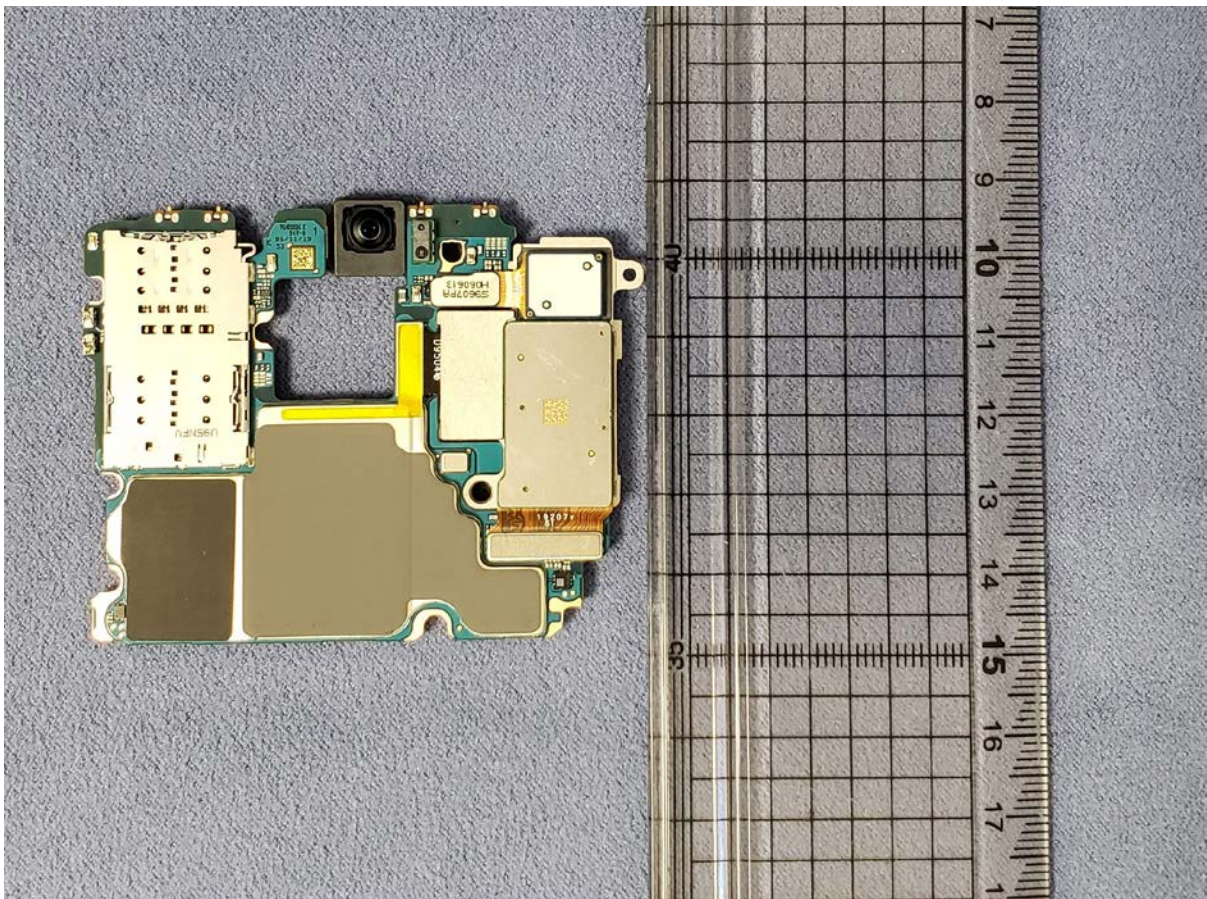
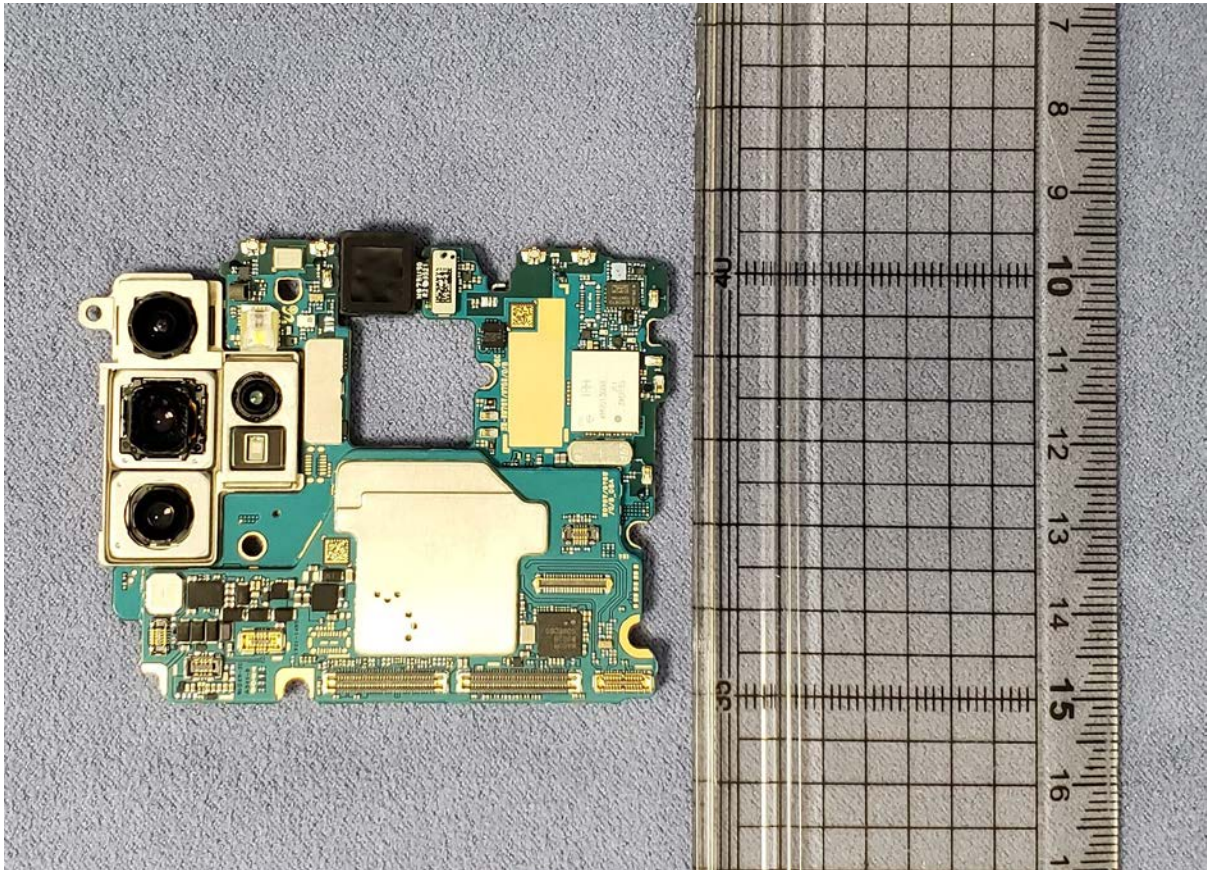
A3LSMN975U

Internal Photographs



A3LSMN975U

Internal Photographs



A photograph of a disassembled smartphone, likely a Google Pixel 2, showing the internal components laid out on a blue surface next to a ruler for scale. The main logic board is green and populated with various chips, including a large central processor (likely a Qualcomm Snapdragon 821). To the left of the main board is the camera module, which includes three lenses and a flash. Above the main board is a smaller black component, possibly a battery or a sensor. Below the main board is a white plastic piece, likely a SIM card tray. The ruler on the right indicates the size of the components, with markings from 1 to 20 cm.

A photograph of a disassembled smartphone, likely a Google Pixel 2, showing the internal components. The main logic board is green and populated with various chips, including the Qualcomm Snapdragon 821 (Q821) and the Google M821. The camera module is visible on the left, featuring three lenses and a flash. The battery is a large, yellow, rectangular component. A white plastic piece, possibly a SIM card tray or a part of the chassis, is shown at the bottom. A ruler is placed vertically on the right side of the image for scale, indicating the size of the components.

